

Dual P-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	-40					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -10 \text{ V}$	0.027					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.034					
Q _g typ. (nC)	21.7					
I _D (A) ^d	-8					
Configuration	Dual					

FEATURES

- TrenchFET® power MOSFET
- 100 % R_g and UIS tested

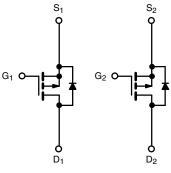




ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Load switches
 - Notebook PCs
 - Desktop PCs



P-Channel MOSFET P-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4909DY-T1-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V_{DS}	-40		
Gate-source voltage		V_{GS}	± 20	V	
	T _C = 25 °C		-8		
Continuous dusin surrent /T. 150 °C\	T _C = 70 °C	1 . [-6.5		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	l _D	-6.4 ^{a, b}		
	T _A = 70 °C		-5.1 ^{a, b}		
Pulsed drain current	I _{DM}	-30 e	Α		
Continuous accura dusin diada accurat	T _C = 25 °C	- I _S	-2.6		
Continuous source-drain diode current	T _A = 25 °C		-1.6 ^{a, b}		
Avalanche current			-20		
Single-pulse avalanche energy	L = 0.1 mH	E _{AS}	20	mJ	
	T _C = 25 °C	P _D	3.2	W	
Martin and a state of the state	T _C = 70 °C		2.1		
Maximum power dissipation	T _A = 25 °C		2 a, b		
	T _A = 70 °C	1	1.28 ^{a, b}	1	
Operating junction and storage temperature range	T _J , T _{stq}	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, c	t ≤ 10 s	R _{thJA}	47	62.5	°C/W	
Maximum junction-to-foot	Steady state	R _{thJF}	29	38]	

Notes

- a. Surface mounted on 1" x 1" FR4 board
- o. t = 10 s
- c. Maximum under steady state conditions is 110 °C/W
- d. Based on T_C = 25 $^{\circ}C$
- e. Limited by package



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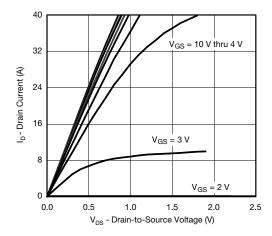
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•		•		
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-40	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-34	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	4.8	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.2	-	-2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
	I _{DSS}	V _{DS} = -40 V, V _{GS} = 0 V	-	-	-1	μА	
Zero gate voltage drain current		V _{DS} = -40 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-20	-	-	Α	
Data a succession and a succession and a	5	V _{GS} = -10 V, I _D = -8 A	-	0.021	0.027	Ω	
Drain-source on-state resistance a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	0.027	0.034		
Forward transconductance a	9 _{fs}	$V_{DS} = -10 \text{ V}, I_D = -8 \text{ A}$	-	22	-	S	
Dynamic ^b			•		•	•	
Input capacitance	C _{iss}		-	2000	-		
Output capacitance	C _{oss}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	240	-	pF	
Reverse transfer capacitance	C _{rss}		-	202	-	1	
Total gate charge	Q_g	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -10 \text{ A}$	-	41.5	63	nC	
			-	21.7	33		
Gate-source charge	Q _{gs}	$V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -10 \text{ A}$	-	5.6	-		
Gate-drain charge	Q _{qd}		-	9.8	-		
Gate resistance	R_{g}	f = 1 MHz	1.5	6	12	Ω	
Turn-on delay time	t _{d(on)}		-	10	20		
Rise time	t _r	$V_{DD} = -20 \text{ V}, R_L = 2 \Omega$	-	9	18	1	
Turn-off delay time	t _{d(off)}	$I_D \cong -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	50	90	1	
Fall time	t _f		-	13	26	1	
Turn-on delay time	t _{d(on)}		-	42	75	ns	
Rise time	t _r	V_{DD} = -20 V, R_L = 2 Ω	-	40	70		
Turn-off delay time	t _{d(off)}	$I_D \cong -10$ Å, $V_{GEN} = -4.5$ V, $R_g = 1$ Ω	-	40	70	1	
Fall time	t _f		-	18	35	1	
Drain-Source Body Diode Characteris	tics		•		•	•	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-2.6		
Pulse diode forward current	I _{SM}		-	-	-30	Α	
Body diode voltage	V _{SD}	I _S = -2 A, V _{GS} = 0 V	-	-0.75	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	41	80	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = -2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	32	65	nC	
Reverse recovery fall time	t _a	T _J = 25 °C	-	15	-		
Reverse recovery rise time	t _b		-	26	_	ns	

Notes

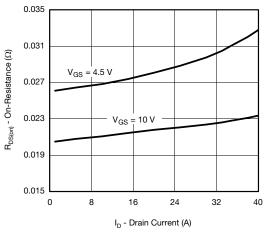
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

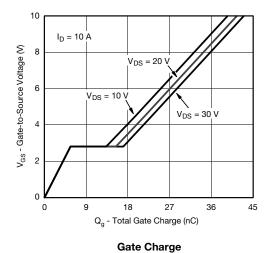


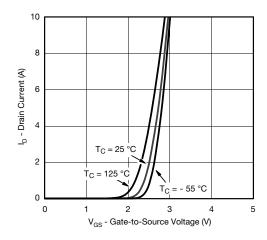


Output Characteristics

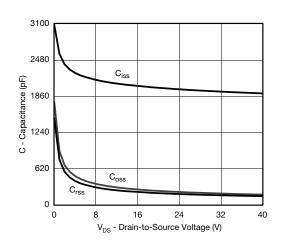


On-Resistance vs. Drain Current

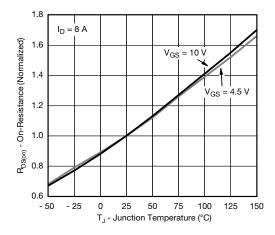




Transfer Characteristics

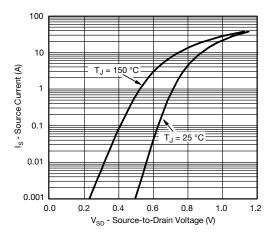


Capacitance

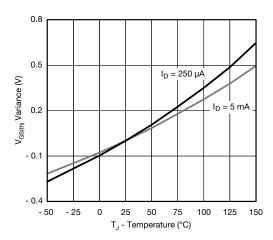


On-Resistance vs. Junction Temperature

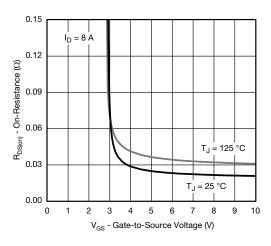




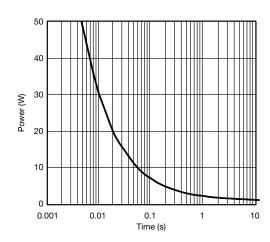
Source-Drain Diode Forward Voltage



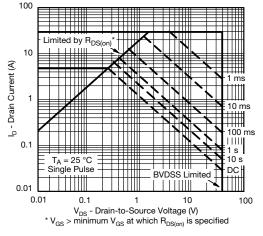
Threshold Voltage



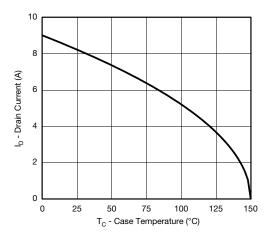
On-Resistance vs. Gate-to-Source Voltage



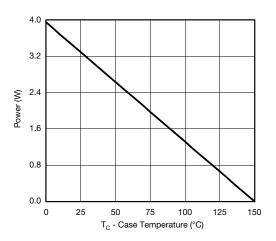
Single Pulse Power, Junction-to-Ambient

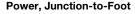


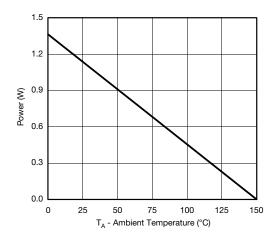




Current Derating a





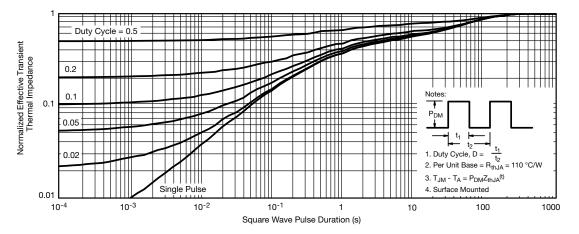


Power Derating, Junction-to-Ambient

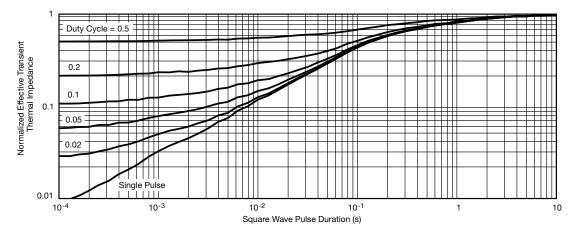
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



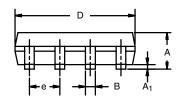
Normalized Thermal Transient Impedance, Junction-to-Foot

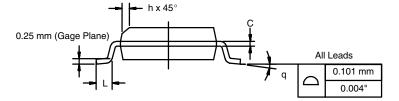
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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